

Inductors

RF chokes, LBC series

Series/Type: B82144B Date: June 2012

© EPCOS AG 2015. Reproduction, publication and dissemination of this publication, enclosures hereto and the information contained therein without EPCOS' prior express consent is prohibited.

EPCOS AG is a TDK Group Company.



B82144B

RF chokes

LBC series, 6.5 x 9.2 (mm)

LBC choke, radial leaded Rated inductance 1 ... 100 000 µH Rated current 20 ... 2500 mA

Construction

- Large ferrite drum core
- Winding: enamel copper wire
- Flame-retardant lacquer coating
- Non laquered lead wire

Features

- Very wide inductance range
- High rated current
- Suitable for wave soldering
- RoHS-compatible

Applications

- RF blocking and filtering
- Decoupling and interference suppression
- For telecommunications, automotive electronics, energy-saving lamps, entertainment electronics

Terminals

- Radially bent to 5 mm lead spacing
- Base material CuAg0.1
- Electroplated with nickel and pure tin

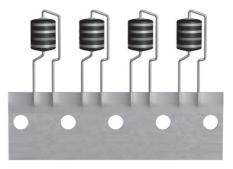
Marking

Inductance indicated by color bands to IEC 60062

Delivery mode and packing units

- Taped, reel packing
- Packing units:

	Ammo (pcs./pack.)	Reel (pcs./reel)
B82144B (radial)		1000

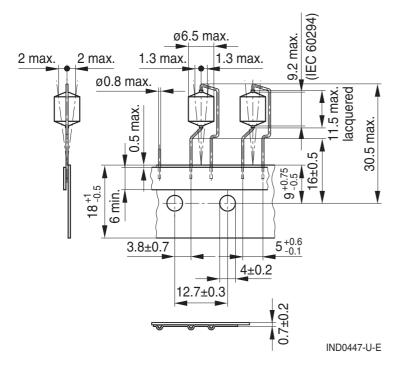




RF chokes

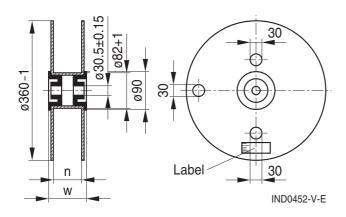
LBC series, 6.5 x 9.2 (mm)

Dimensional drawing



Dimensions in mm

Packing



n (mm): 72 +1 w (mm): 84 max

Dimensions in mm

Please read *Cautions and warnings* and *Important notes* at the end of this document.





RF chokes

LBC series, 6.5 x 9.2 (mm)

Technical data and measuring conditions

Rated inductance L _R	Measured with LCR meter Agilent 4284A or impedance analyzer Agilent 4294A				
	Measuring frequency: $L_R \le 10 \ \mu H = 1 \ MHz$ $10 \ \mu H < L_R \le 4700 \ \mu H = 100 \ kHz$ $L_R > 4700 \ \mu H = 10 \ kHz$				
	Measuring current: $\leq 1 \text{ mA}$				
	Measuring temperature: +20 °C				
Q factor Q _{min}	Measured with precision impedance analyzer Agilent 4294A, +20 °C				
Rated temperature T _R	+40 °C				
Rated current I _R	Maximum permissible DC current at rated temperature				
Inductance decrease $\Delta L/L_0$	\leq 10% (referred to initial value) at I _R , +20 °C				
DC resistance R _{max}	Measured at +20 °C				
Resonance frequency f _{res,min}	Measured with Agilent 4294A or 8753ES, +20 °C				
Solderability (lead-free)	Sn95.5Ag3.8Cu0.7: +(245 \pm 5) °C, (3 \pm 0.3) s Wetting of soldering area \geq 90% (to IEC 60068-2-20, test Ta)				
Resistance to soldering heat	+(260 ±5) °C, 10 s (to IEC 60068-2-20, test Tb)				
Tensile strength of leads	≥ 20 N (to IEC 60068-2-21, test Ua)				
Climatic category	55/125/56 (to IEC 60068-1)				
Storage conditions	Mounted: $-55 \ ^{\circ}C \ \dots +125 \ ^{\circ}C$ Packaged: $-25 \ ^{\circ}C \ \dots +40 \ ^{\circ}C, \le 75\% \ RH$				
Weight	Approx. 0.95 g				

▲ Mounting information

When bending the leads, take care that the start-of-winding areas at the face ends (protected by glue and lacquer) are not subjected to any mechanical stress.



RF chokes

LBC series, 6.5 x 9.2 (mm)

Characteristics and ordering codes

L _R μΗ	Tolerance ¹⁾	Q _{min}	f _Q MHz	I _R mA	R _{max} Ω	f _{res,min} MHz	Ordering code
1.0	±10% ≙ K	25	7.96	2500	0.06	200	B82144B1102K000
1.5		25	7.96	2300	0.07	180	B82144B1152K000
2.2		25	7.96	2100	0.09	140	B82144B1222K000
3.3		25	7.96	1950	0.10	120	B82144B1332K000
4.7		25	7.96	1800	0.12	100	B82144B1472K000
6.8		25	7.96	1600	0.15	60	B82144B1682K000
10		60	2.52	1500	0.18	24	B82144B1103K000
15		60	2.52	1400	0.22	17	B82144B1153K000
22		50	2.52	1250	0.28	12	B82144B1223K000
33	±5% ≙ J	40	2.52	1100	0.35	8.0	B82144B1333J000
47		40	2.52	900	0.41	7.0	B82144B1473J000
56		40	2.52	850	0.47	7.0	B82144B1563J000
68		30	2.52	800	0.52	6.2	B82144B1683J000
100		40	0.796	760	0.70	5.2	B82144B1104J000
150		40	0.796	670	0.90	4.5	B82144B1154J000
220		40	0.796	550	1.30	3.8	B82144B1224J000
330		30	0.796	500	1.70	3.2	B82144B1334J000
470		30	0.796	400	2.20	2.9	B82144B1474J000
680		20	0.796	340	3.10	2.6	B82144B1684J000
820		20	0.796	310	3.70	2.4	B82144B1824J000
1000		60	0.252	280	4.20	2.2	B82144B1105J000
1500		60	0.252	230	6.40	1.9	B82144B1155J000
2200		60	0.252	180	9.50	1.5	B82144B1225J000
3300		60	0.252	150	13.8	1.3	B82144B1335J000
4700		60	0.252	120	21.0	1.1	B82144B1475J000
5600		60	0.252	110	28.0	1.0	B82144B1565J000
6800		60	0.252	100	30.0	0.9	B82144B1685J000
10000		50	0.0796	85	42.0	0.75	B82144B1106J000
15000		50	0.0796	50	75.0	0.50	B82144B1156J000
22000		50	0.0796	40	120	0.40	B82144B1226J000
33000		50	0.0796	35	150	0.30	B82144B1336J000
47000		40	0.0796	30	230	0.26	B82144B1476J000
68000		40	0.0796	25	290	0.20	B82144B1686J000
100000		40	0.0796	20	490	0.18	B82144B1107J000

1) Closer tolerances on request.

B82144B



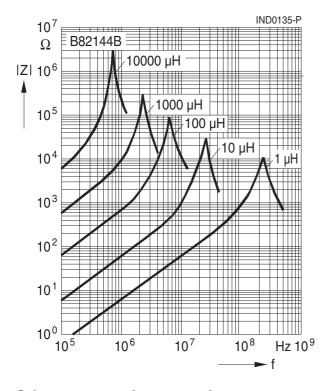
B82144B

RF chokes

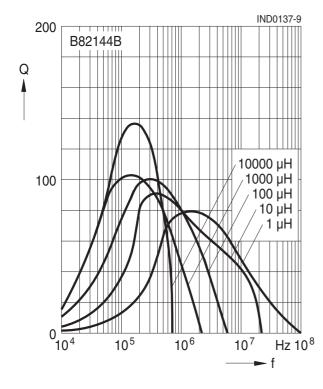
LBC series, 6.5 x 9.2 (mm)

Impedance |Z| versus frequency f

measured with impedance analyzer Agilent 4294A or S-parameter network analyzer Agilent 8753ES, typical values at +20 °C

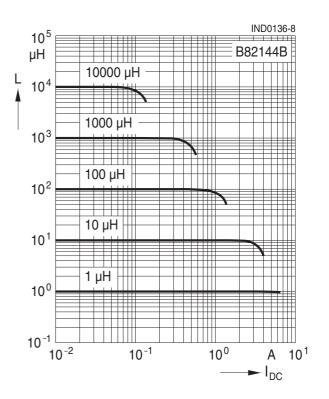


Q factor versus frequency f measured with impedance analyzer Agilent 4294A, typical values at +20 °C

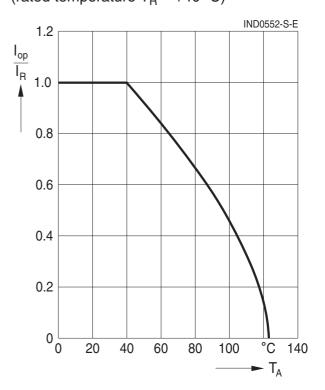


Inductance L versus DC load current I_{DC}

measured with LCR meter Agilent 4284A, typical values at +20 °C



Current derating I_{op}/I_R versus ambient temperature T_A (rated temperature $T_R = +40 \ ^\circ C$)



6



Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.

Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.

- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order.

We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

- 6. Unless otherwise agreed in individual contracts, all orders are subject to our General Terms and Conditions of Supply.
- 7. Our manufacturing sites serving the automotive business apply the IATF 16949 standard. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that only requirements mutually agreed upon can and will be implemented in our Quality Management System. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
- 8. The trade names EPCOS, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, ThermoFuse, WindCap are trademarks registered or pending in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

Release 2018-10

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Fixed Inductors category:

Click to view products by EPCOS manufacturer:

Other Similar products are found below :

MLZ1608M6R8WTD25 MLZ1608N6R8LT000 MLZ1608N3R3LTD25 MLZ1608N3R3LT000 MLZ1608N150LT000 MLZ1608M150WTD25 MLZ1608M3R3WTD25 MLZ1608M3R3WT000 MLZ1608M150WT000 MLZ1608A1R5WT000 MLZ1608N1R5LT000 B82432C1333K000 PCMB053T-1R0MS PCMB053T-1R5MS PCMB104T-1R5MS CR32NP-100KC CR32NP-151KC CR32NP-180KC CR32NP-181KC CR32NP-1R5MC CR32NP-390KC CR32NP-3R9MC CR32NP-680KC CR32NP-820KC CR32NP-8R2MC CR43NP-390KC CR43NP-560KC CR43NP-680KC CR54NP-181KC CR54NP-470LC CR54NP-820KC CR54NP-8R5MC MGDQ4-00004-P MGDU1-00016-P MHL1ECTTP18NJ MHL1JCTTD12NJ PE-51506NL PE-53601NL PE-53630NL PE-53824SNLT PE-62892NL PE-92100NL PG0434.801NLT PG0936.113NLT PM06-2N7 PM06-39NJ HC2LP-R47-R HC2-R47-R HC3-2R2-R HC8-1R2-R